

**Amendments to the Specification:**

*The following page and line numbers refer to those in the original specification as filed.*

On page 5, line 22, amend the paragraph beginning with “Fig. 2 shows” as follows:

-- FIG. 2 shows a schematic sectional view of a detail from a first embodiment of the optoelectronic component; [[and]] --

On page 5, line 26, amend the paragraph beginning with “Fig. 3 shows” as follows:

-- FIG. 3 shows a schematic sectional view of a detail from a second embodiment of the optoelectronic component; [[.]] --

On page 5, before line 30, add the following new paragraphs:

-- Fig. 4 shows a schematic sectional view of a variation of the optoelectronic component shown in Fig. 2; and

Fig. 5 shows a schematic sectional view of a variation of the optoelectronic component shown in Fig. 3. --

On page 12, line 29, amend the paragraph beginning with “Subsequently, the chip composite base 5” as follows:

-- Subsequently, the chip composite base 5 with the applied material can be singulated to form a plurality of optoelectronic semiconductor chips. Each of these semiconductor chips comprises a plurality of structural elements 12, as is shown in Figs. 4 and 5. --